



Micro Commercial Components Corp.

Complete Discrete Semiconductor Solutions

Product Catalog > Diodes > Standard Recovery Rectifiers >	
Part Number	GS1B
product family	STANDARD RECOVERY RECTIFIERS
package type	DO-214AC
VRM(PRV)	100V
Ifsm	30A
IF(AV)	1.0A
@Vf	1.1V
@If	1.0A
Trr	
IR	10μA
@VR	100V
Package Qty	Tape : 3K/Reel, 48K/Ctn;
This product is listed under the following categories where you may find similar products: Diodes Standard Recovery Rectifiers	



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GS1A THRU GS1M

Features

- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0 and MSL rating 1
- Low Thermal Resistance
- High Temp Soldering: 260°C for 10 Seconds At Terminals
- Lead Free Finish/Rohs Compliant (Note1) ("P" Suffix designates Compliant. See ordering information)

Maximum Ratings

- Operating Temperature: -55°C to +150°C
- Storage Temperature: -55°C to +150°C
- Maximum Thermal Resistance; 15°C/W Junction To Lead

MCC Catalog Number	Device Marking	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
GS1A	GS1A	50V	35V	50V
GS1B	GS1B	100V	70V	100V
GS1D	GS1D	200V	140V	200V
GS1G	GS1G	400V	280V	400V
GS1J	GS1J	600V	420V	600V
GS1K	GS1K	800V	560V	800V
GS1M	GS1M	1000V	700V	1000V

Electrical Characteristics @ 25°C Unless Otherwise Specified

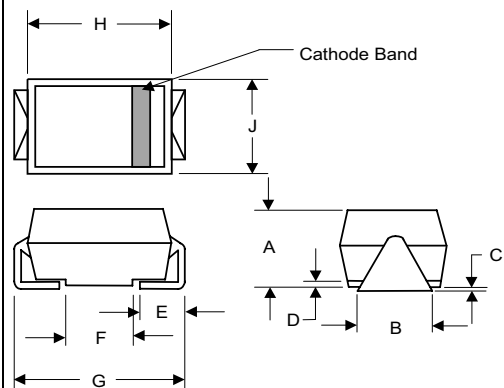
Average Forward current	$I_{F(AV)}$	1.0A	$T_a = 75^\circ\text{C}$
Peak Forward Surge Current	I_{FSM}	30A	8.3ms, half sine,
Maximum Instantaneous Forward Voltage	V_F	1.1V	$I_{FM} = 1.0\text{A};$ $T_J = 25^\circ\text{C}^*$
Maximum DC Reverse Current At Rated DC Blocking Voltage	I_R	10 μA 50 μA	$T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$
Typical Junction Capacitance	C_J	15pF	Measured at 1.0MHz, $V_R=4.0\text{V}$

*Pulse test: Pulse width 300 μsec , Duty cycle 2%

Note: 1. High Temperature Solder Exemptions Applied, see EU Directive Annex 7.

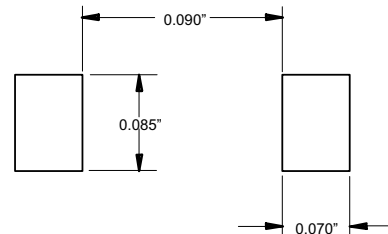
1 Amp Silicon Rectifier 50 to 1000 Volts

DO-214AC (HSMA) (High Profile)



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	.078	.116	1.98	2.95	
B	.067	.089	1.70	2.25	
C	.002	.008	.05	.20	
D	—	.02	—	.51	
E	.035	.055	.89	1.40	
F	.065	.096	1.65	2.45	
G	.205	.224	5.21	5.69	
H	.160	.180	4.06	4.57	
J	.100	.112	2.57	2.84	

SUGGESTED SOLDER PAD LAYOUT





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Ordering Information

Device	Packing
(Part Number)-TP	Tape&Reel;3Kpcs/Reel

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